



Welcome to [E-XFL.COM](#)

#### What is "[Embedded - Microcontrollers](#)"?

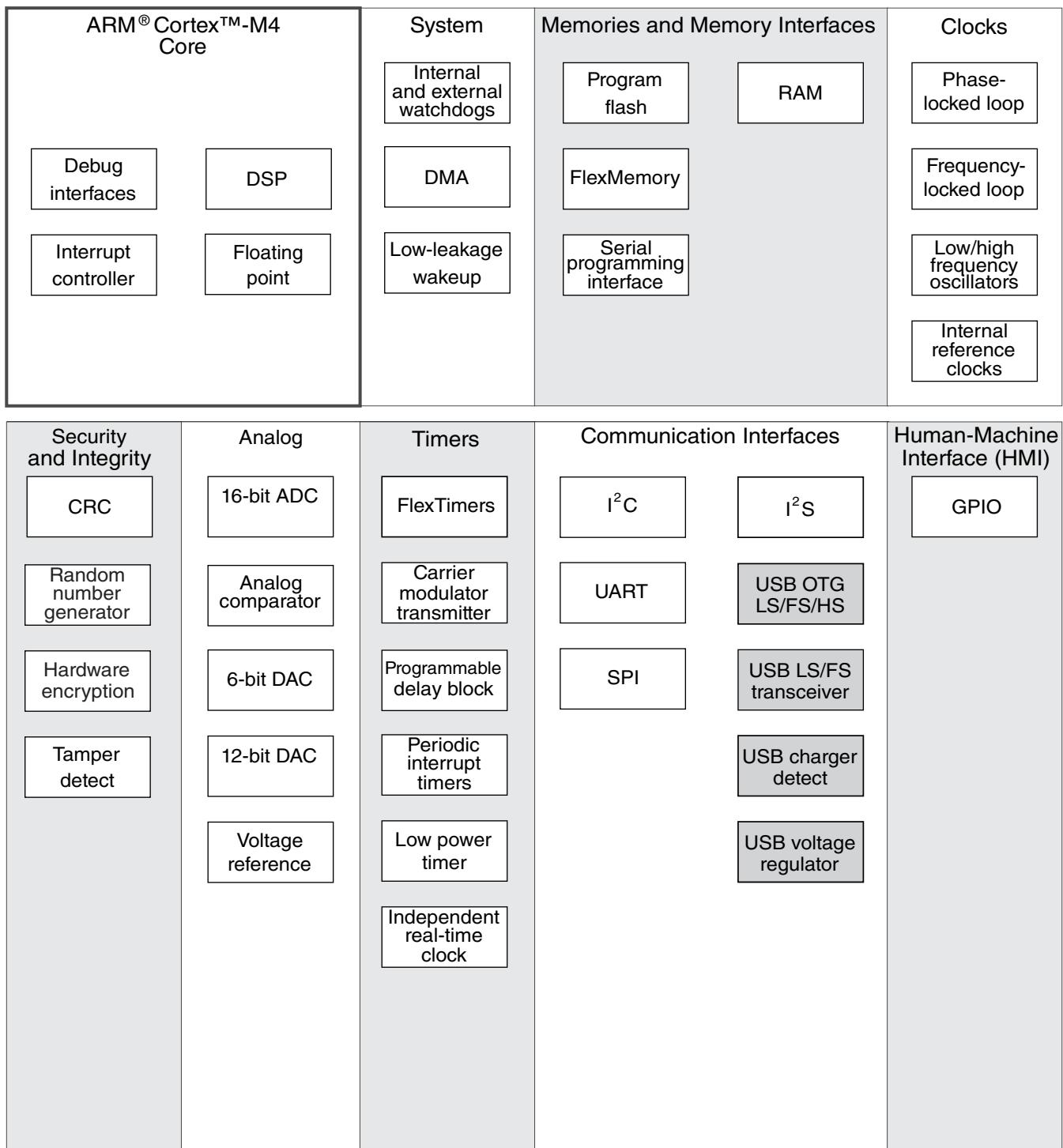
"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Active
Core Processor	-
Core Size	-
Speed	-
Connectivity	-
Peripherals	-
Number of I/O	-
Program Memory Size	-
Program Memory Type	-
EEPROM Size	-
RAM Size	-
Voltage - Supply (Vcc/Vdd)	-
Data Converters	-
Oscillator Type	-
Operating Temperature	-
Mounting Type	-
Package / Case	-
Supplier Device Package	-
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/mk21fx512avmd12">https://www.e-xfl.com/product-detail/nxp-semiconductors/mk21fx512avmd12</a>

## Kinetis K21D Family



**Figure 1. K20 block diagram**

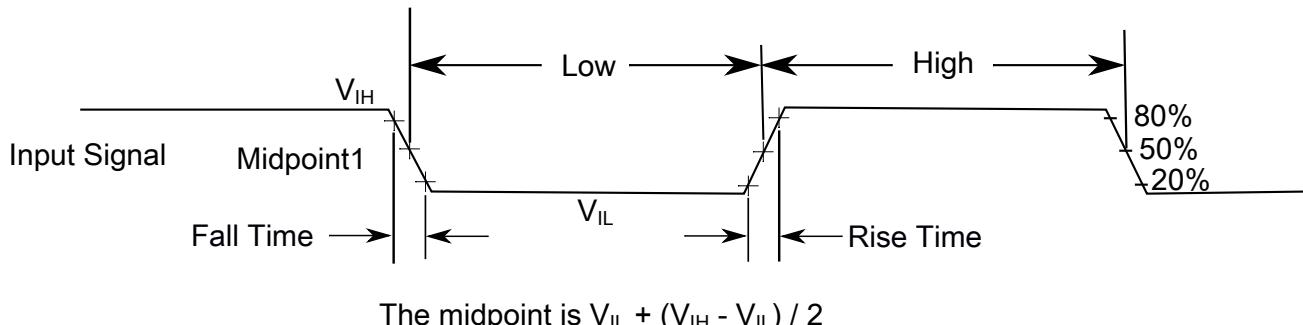
Symbol	Description	Min.	Max.	Unit
$V_{DD}$	Digital supply voltage	-0.3	3.8	V
$I_{DD}$	Digital supply current	—	185	mA
$V_{DIO}$	Digital input voltage (except RESET, EXTAL, and XTAL)	-0.3	5.5	V
$V_{AIO}$	Analog <sup>1</sup> , RESET, EXTAL, and XTAL input voltage	-0.3	$V_{DD} + 0.3$	V
$I_D$	Maximum current single pin limit (applies to all digital pins)	-25	25	mA
$V_{DDA}$	Analog supply voltage	$V_{DD} - 0.3$	$V_{DD} + 0.3$	V
$V_{USB0\_DP}$	USB0_DP input voltage	-0.3	3.63	V
$V_{USB0\_DM}$	USB0_DM input voltage	-0.3	3.63	V
$V_{BAT}$	RTC battery supply voltage	-0.3	3.8	V

1. Analog pins are defined as pins that do not have an associated general purpose I/O port function.

## 2 General

### 2.1 AC electrical characteristics

Unless otherwise specified, propagation delays are measured from the 50% to the 50% point, and rise and fall times are measured at the 20% and 80% points, as shown in the following figure.



**Figure 2. Input signal measurement reference**

All digital I/O switching characteristics assume:

1. output pins
  - have  $C_L = 30\text{pF}$  loads,
  - are configured for fast slew rate ( $\text{PORTx\_PCRn[SRE]}=0$ ), and
  - are configured for high drive strength ( $\text{PORTx\_PCRn[DSE]}=1$ )
2. input pins
  - have their passive filter disabled ( $\text{PORTx\_PCRn[PFE]}=0$ )

**General**

2. Analog pins are defined as pins that do not have an associated general purpose I/O port function. Additionally, EXTAL and XTAL are analog pins.
3. All analog pins are internally clamped to  $V_{SS}$  and  $V_{DD}$  through ESD protection diodes. If  $V_{IN}$  is less than  $V_{AIO\_MIN}$  or greater than  $V_{AIO\_MAX}$ , a current limiting resistor is required. The negative DC injection current limiting resistor is calculated as  $R=(V_{AIO\_MIN}-V_{IN})/I_{ICAIOL}$ . The positive injection current limiting resistor is calculated as  $R=(V_{IN}-V_{AIO\_MAX})/I_{ICAIOL}$ . Select the larger of these two calculated resistances if the pin is exposed to positive and negative injection currents.
4. Open drain outputs must be pulled to  $VDD$ .

**2.2.2 LVD and POR operating requirements****Table 2.  $V_{DD}$  supply LVD and POR operating requirements**

<b>Symbol</b>	<b>Description</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Unit</b>	<b>Notes</b>
$V_{POR}$	Falling $VDD$ POR detect voltage	0.8	1.1	1.5	V	
$V_{LVDH}$	Falling low-voltage detect threshold — high range ( $LVDV=01$ )	2.48	2.56	2.64	V	
$V_{LVW1H}$	Low-voltage warning thresholds — high range					1
	• Level 1 falling ( $LVWV=00$ )	2.62	2.70	2.78	V	
$V_{LVW2H}$	• Level 2 falling ( $LVWV=01$ )	2.72	2.80	2.88	V	
$V_{LVW3H}$	• Level 3 falling ( $LVWV=10$ )	2.82	2.90	2.98	V	
$V_{LVW4H}$	• Level 4 falling ( $LVWV=11$ )	2.92	3.00	3.08	V	
$V_{HYSH}$	Low-voltage inhibit reset/recover hysteresis — high range	—	80	—	mV	
$V_{LVDL}$	Falling low-voltage detect threshold — low range ( $LVDV=00$ )	1.54	1.60	1.66	V	
$V_{LVW1L}$	Low-voltage warning thresholds — low range					1
	• Level 1 falling ( $LVWV=00$ )	1.74	1.80	1.86	V	
$V_{LVW2L}$	• Level 2 falling ( $LVWV=01$ )	1.84	1.90	1.96	V	
$V_{LVW3L}$	• Level 3 falling ( $LVWV=10$ )	1.94	2.00	2.06	V	
$V_{LVW4L}$	• Level 4 falling ( $LVWV=11$ )	2.04	2.10	2.16	V	
$V_{HYSL}$	Low-voltage inhibit reset/recover hysteresis — low range	—	60	—	mV	
$V_{BG}$	Bandgap voltage reference	0.97	1.00	1.03	V	
$t_{LPO}$	Internal low power oscillator period — factory trimmed	900	1000	1100	$\mu s$	

1. Rising threshold is the sum of falling threshold and hysteresis voltage

**Table 3.  $V_{BAT}$  power operating requirements**

<b>Symbol</b>	<b>Description</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Unit</b>	<b>Notes</b>
$V_{POR\_VBAT}$	Falling $V_{BAT}$ supply POR detect voltage	0.8	1.1	1.5	V	

## 2.2.3 Voltage and current operating behaviors

Table 4. Voltage and current operating behaviors

Symbol	Description	Min.	Typ	Max.	Unit	Notes
$V_{OH}$	Output high voltage — high drive strength					
	<ul style="list-style-type: none"> <li><math>2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}, I_{OH} = -8\text{mA}</math></li> <li><math>1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}, I_{OH} = -3\text{mA}</math></li> </ul>	$V_{DD} - 0.5$	—	—	V	
$V_{OH\_Tamper}$	Output high voltage — low drive strength					
	<ul style="list-style-type: none"> <li><math>2.7 \text{ V} \leq V_{BAT} \leq 3.6 \text{ V}, I_{OH} = -2\text{mA}</math></li> <li><math>1.71 \text{ V} \leq V_{BAT} \leq 2.7 \text{ V}, I_{OH} = -0.6\text{mA}</math></li> </ul>	$V_{BAT} - 0.5$	—	—	V	
$I_{OH\_T}$	Output high current total for all ports	—	—	100	mA	
$V_{OH\_T}$	Output high voltage — high drive strength	$V_{BAT} - 0.5$			V	
	<ul style="list-style-type: none"> <li><math>2.7 \text{ V} \leq V_{BAT} \leq 3.6 \text{ V}, I_{OH} = -10\text{mA}</math></li> <li><math>1.71 \text{ V} \leq V_{BAT} \leq 2.7 \text{ V}, I_{OH} = -3\text{mA}</math></li> </ul>	$V_{BAT} - 0.5$	—	—	V	
$I_{OH\_T}$	Output high voltage — low drive strength	$V_{BAT} - 0.5$			V	
	<ul style="list-style-type: none"> <li><math>2.7 \text{ V} \leq V_{BAT} \leq 3.6 \text{ V}, I_{OH} = -2\text{mA}</math></li> <li><math>1.71 \text{ V} \leq V_{BAT} \leq 2.7 \text{ V}, I_{OH} = -0.6\text{mA}</math></li> </ul>	$V_{BAT} - 0.5$	—	—	V	
$I_{OH\_T}$	Output high current total for Tamper pins	—	—	100	mA	
$V_{OL}$	Output low voltage — high drive strength					1
	<ul style="list-style-type: none"> <li><math>2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}, I_{OL} = 9\text{mA}</math></li> <li><math>1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}, I_{OL} = 3\text{mA}</math></li> </ul>	—	—	0.5	V	
$V_{OL\_T}$	Output low voltage — low drive strength					
	<ul style="list-style-type: none"> <li><math>2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}, I_{OL} = 2\text{mA}</math></li> <li><math>1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}, I_{OL} = 0.6\text{mA}</math></li> </ul>	—	—	0.5	V	
$I_{OL\_T}$	Output low current total for all ports	—	—	100	mA	
$V_{OL\_T}$	Output low voltage — high drive strength			0.5	V	
	<ul style="list-style-type: none"> <li><math>2.7 \text{ V} \leq V_{BAT} \leq 3.6 \text{ V}, I_{OL} = 10\text{mA}</math></li> <li><math>1.71 \text{ V} \leq V_{BAT} \leq 2.7 \text{ V}, I_{OL} = 3\text{mA}</math></li> </ul>	—	—	0.5	V	
$I_{OL\_T}$	Output low voltage — low drive strength			0.5	V	
	<ul style="list-style-type: none"> <li><math>2.7 \text{ V} \leq V_{BAT} \leq 3.6 \text{ V}, I_{OL} = 2\text{mA}</math></li> <li><math>1.71 \text{ V} \leq V_{BAT} \leq 2.7 \text{ V}, I_{OL} = 0.6\text{mA}</math></li> </ul>	—	—	0.5	V	
$I_{OL\_T}$	Output low current total for Tamper pins	—	—	100	mA	
$I_{IND}$	Input leakage current, digital pins <ul style="list-style-type: none"> <li><math>V_{SS} \leq V_{IN} \leq V_{IL}</math></li> <li>All digital pins</li> </ul>	—	0.002	0.5	$\mu\text{A}$	2, 3

Table continues on the next page...

**Table 5. Power mode transition operating behaviors**

Symbol	Description	Min.	Max.	Unit	Notes
t <sub>POR</sub>	After a POR event, amount of time from the point V <sub>DD</sub> reaches 1.71 V to execution of the first instruction across the operating temperature range of the chip.	—	300	μs	
	• VLLS0 → RUN	—	183	μs	
	• VLLS1 → RUN	—	183	μs	
	• VLLS2 → RUN	—	105	μs	
	• VLLS3 → RUN	—	105	μs	
	• LLS → RUN	—	5.0	μs	
	• VLPS → RUN	—	4.4	μs	
	• STOP → RUN	—	4.4	μs	

## 2.2.5 Power consumption operating behaviors

**Table 6. Power consumption operating behaviors**

Symbol	Description	Min.	Typ.	Max.	Unit	Notes
I <sub>DDA</sub>	Analog supply current	—	—	See note	mA	1
I <sub>DD_RUN</sub>	Run mode current — all peripheral clocks disabled, code executing from flash	—	33.57	36.2	mA	2
	• @ 1.8V	—	33.51	36.1	mA	
	• @ 3.0V	—	—	—	mA	
I <sub>DD_RUN</sub>	Run mode current — all peripheral clocks enabled, code executing from flash	—	46.36	50.1	mA	3, 4
	• @ 1.8V	—	46.31	49.9	mA	
	• @ 3.0V	—	57.4	—	mA	
	• @ 25°C	—	—	—	mA	
	• @ 125°C	—	—	—	mA	
I <sub>DD_WAIT</sub>	Wait mode high frequency current at 3.0 V — all peripheral clocks disabled	—	18.2	—	mA	2
I <sub>DD_WAIT</sub>	Wait mode reduced frequency current at 3.0 V — all peripheral clocks disabled	—	7.2	—	mA	5

*Table continues on the next page...*

**Table 6. Power consumption operating behaviors (continued)**

Symbol	Description	Min.	Typ.	Max.	Unit	Notes
I <sub>DD_VLPR</sub>	Very-low-power run mode current at 3.0 V — all peripheral clocks disabled	—	1.21	—	mA	<a href="#">6</a>
I <sub>DD_VLPR</sub>	Very-low-power run mode current at 3.0 V — all peripheral clocks enabled	—	1.88	—	mA	<a href="#">7</a>
I <sub>DD_VLPW</sub>	Very-low-power wait mode current at 3.0 V — all peripheral clocks disabled	—	0.80	—	mA	<a href="#">8</a>
I <sub>DD_STOP</sub>	Stop mode current at 3.0 V • @ -40 to 25°C • @ 70°C • @ 105°C	— — —	0.528 1.6 5.2	2.25 8 20	mA mA mA	
I <sub>DD_VLPS</sub>	Very-low-power stop mode current at 3.0 V • @ -40 to 25°C • @ 70°C • @ 105°C	— — —	78 498 1300	700 2400 3600	μA μA μA	
I <sub>DD_LLS</sub>	Low leakage stop mode current at 3.0 V • @ -40 to 25°C • @ 70°C • @ 105°C	— — —	5.1 28 124	15 80 300	μA μA μA	
I <sub>DD_VLLS3</sub>	Very low-leakage stop mode 3 current at 3.0 V • @ -40 to 25°C • @ 70°C • @ 105°C	— — —	3.1 14.5 63.5	7.5 45 195	μA μA μA	
I <sub>DD_VLLS2</sub>	Very low-leakage stop mode 2 current at 3.0 V • @ -40 to 25°C • @ 70°C • @ 105°C	— — —	2.0 6.9 30	5 32 112	μA μA μA	
I <sub>DD_VLLS1</sub>	Very low-leakage stop mode 1 current at 3.0 V • @ -40 to 25°C • @ 70°C • @ 105°C	— — —	1.25 6.5 37	2.1 18.5 108	μA μA μA	
I <sub>DD_VLLS0</sub>	Very low-leakage stop mode 0 current at 3.0 V with POR detect circuit enabled • @ -40 to 25°C • @ 70°C • @ 105°C	— — —	0.745 6.03 37	1.65 18 108	μA μA μA	

*Table continues on the next page...*

**Table 9. Device clock specifications (continued)**

Symbol	Description	Min.	Max.	Unit	Notes
FB_CLK	FlexBus clock	—	4	MHz	
f <sub>FLASH</sub>	Flash clock	—	0.8	MHz	
f <sub>ERCLK</sub>	External reference clock	—	16	MHz	
f <sub>LPTMR_pin</sub>	LPTMR clock	—	25	MHz	
f <sub>LPTMR_ERCLK</sub>	LPTMR external reference clock	—	16	MHz	
f <sub>FlexCAN_ERCLK</sub>	FlexCAN external reference clock	—	8	MHz	
f <sub>I2S_MCLK</sub>	I2S master clock	—	12.5	MHz	
f <sub>I2S_BCLK</sub>	I2S bit clock	—	4	MHz	

1. The frequency limitations in VLPR mode here override any frequency specification listed in the timing specification for any other module.

### 2.3.2 General switching specifications

These general purpose specifications apply to all pins configured for:

- GPIO signaling
- Other peripheral module signaling not explicitly stated elsewhere

**Table 10. General switching specifications**

Symbol	Description	Min.	Max.	Unit	Notes
	GPIO pin interrupt pulse width (digital glitch filter disabled) — Synchronous path	1.5	—	Bus clock cycles	<a href="#">1, 2</a>
	GPIO pin interrupt pulse width (digital glitch filter disabled, analog filter enabled) — Asynchronous path	100	—	ns	<a href="#">3</a>
	GPIO pin interrupt pulse width (digital glitch filter disabled, analog filter disabled) — Asynchronous path	16	—	ns	<a href="#">3</a>
	External reset pulse width (digital glitch filter disabled)	100	—	ns	<a href="#">3</a>
	Mode select (EZP_CS) hold time after reset deassertion	2	—	Bus clock cycles	
	Port rise and fall time (high drive strength)				<a href="#">4</a>
	• Slew disabled				
	• $1.71 \leq V_{DD} \leq 2.7V$	—	12	ns	
	• $2.7 \leq V_{DD} \leq 3.6V$	—	6	ns	
	• Slew enabled				
	• $1.71 \leq V_{DD} \leq 2.7V$	—	36	ns	
	• $2.7 \leq V_{DD} \leq 3.6V$	—	24	ns	

Table continues on the next page...

### 3.1.2 JTAG electricals

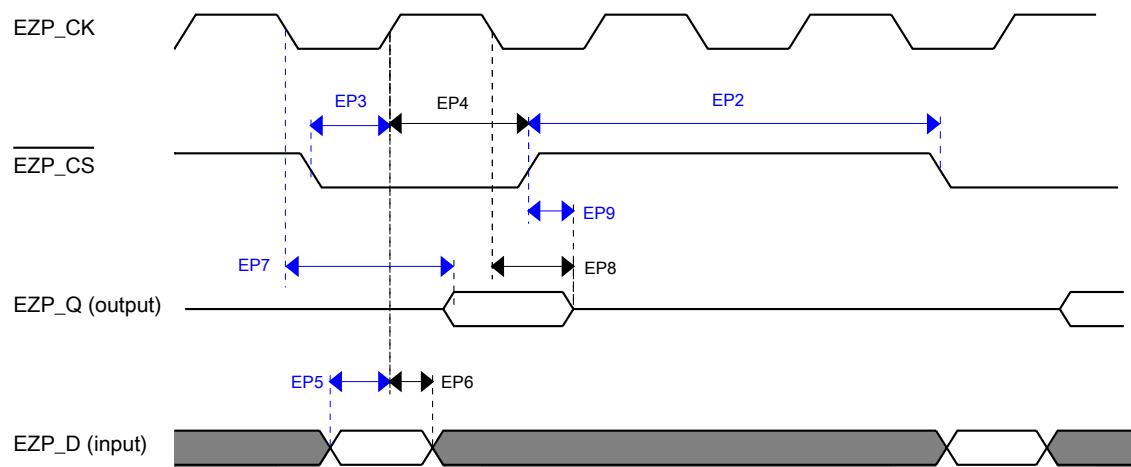
**Table 13. JTAG limited voltage range electricals**

Symbol	Description	Min.	Max.	Unit
	Operating voltage	2.7	3.6	V
J1	TCLK frequency of operation <ul style="list-style-type: none"> <li>• Boundary Scan</li> <li>• JTAG and CJTAG</li> <li>• Serial Wire Debug</li> </ul>	0	10	MHz
		0	25	
		0	50	
J2	TCLK cycle period	1/J1	—	ns
J3	TCLK clock pulse width <ul style="list-style-type: none"> <li>• Boundary Scan</li> <li>• JTAG and CJTAG</li> <li>• Serial Wire Debug</li> </ul>	50	—	ns
		20	—	ns
		10	—	ns
J4	TCLK rise and fall times	—	3	ns
J5	Boundary scan input data setup time to TCLK rise	20	—	ns
J6	Boundary scan input data hold time after TCLK rise	2.6	—	ns
J7	TCLK low to boundary scan output data valid	—	25	ns
J8	TCLK low to boundary scan output high-Z	—	25	ns
J9	TMS, TDI input data setup time to TCLK rise	8	—	ns
J10	TMS, TDI input data hold time after TCLK rise	1	—	ns
J11	TCLK low to TDO data valid	—	17	ns
J12	TCLK low to TDO high-Z	—	17	ns
J13	TRST assert time	100	—	ns
J14	TRST setup time (negation) to TCLK high	8	—	ns

**Table 14. JTAG full voltage range electricals**

Symbol	Description	Min.	Max.	Unit
	Operating voltage	1.71	3.6	V
J1	TCLK frequency of operation <ul style="list-style-type: none"> <li>• Boundary Scan</li> <li>• JTAG and CJTAG</li> <li>• Serial Wire Debug</li> </ul>	0	10	MHz
		0	20	
		0	40	
J2	TCLK cycle period	1/J1	—	ns
J3	TCLK clock pulse width <ul style="list-style-type: none"> <li>• Boundary Scan</li> <li>• JTAG and CJTAG</li> <li>• Serial Wire Debug</li> </ul>	50	—	ns
		25	—	ns
		12.5	—	ns

*Table continues on the next page...*



**Figure 12. EzPort Timing Diagram**

### 3.4.3 Flexbus switching specifications

All processor bus timings are synchronous; input setup/hold and output delay are given in respect to the rising edge of a reference clock, FB\_CLK. The FB\_CLK frequency may be the same as the internal system bus frequency or an integer divider of that frequency.

The following timing numbers indicate when data is latched or driven onto the external bus, relative to the Flexbus output clock (FB\_CLK). All other timing relationships can be derived from these values.

**Table 25. Flexbus limited voltage range switching specifications**

Num	Description	Min.	Max.	Unit	Notes
	Operating voltage	2.7	3.6	V	
	Frequency of operation	—	FB_CLK	MHz	
FB1	Clock period	20	—	ns	
FB2	Address, data, and control output valid	—	11.5	ns	1
FB3	Address, data, and control output hold	0.5	—	ns	1
FB4	Data and FB_TA input setup	8.5	—	ns	2
FB5	Data and FB_TA input hold	0.5	—	ns	2

1. Specification is valid for all FB\_AD[31:0], FB\_BE/BWE<sub>n</sub>, FB\_CS<sub>n</sub>, FB\_OE, FB\_R/W, FB\_TBST, FB\_TSIZ[1:0], FB\_ALE, and FB\_TS.

## 3.6 Analog

### 3.6.1 ADC electrical specifications

The 16-bit accuracy specifications listed in [Table 27](#) and [Table 28](#) are achievable on the differential pins ADCx\_DP0, ADCx\_DM0.

All other ADC channels meet the 13-bit differential/12-bit single-ended accuracy specifications.

#### 3.6.1.1 16-bit ADC operating conditions

**Table 27. 16-bit ADC operating conditions**

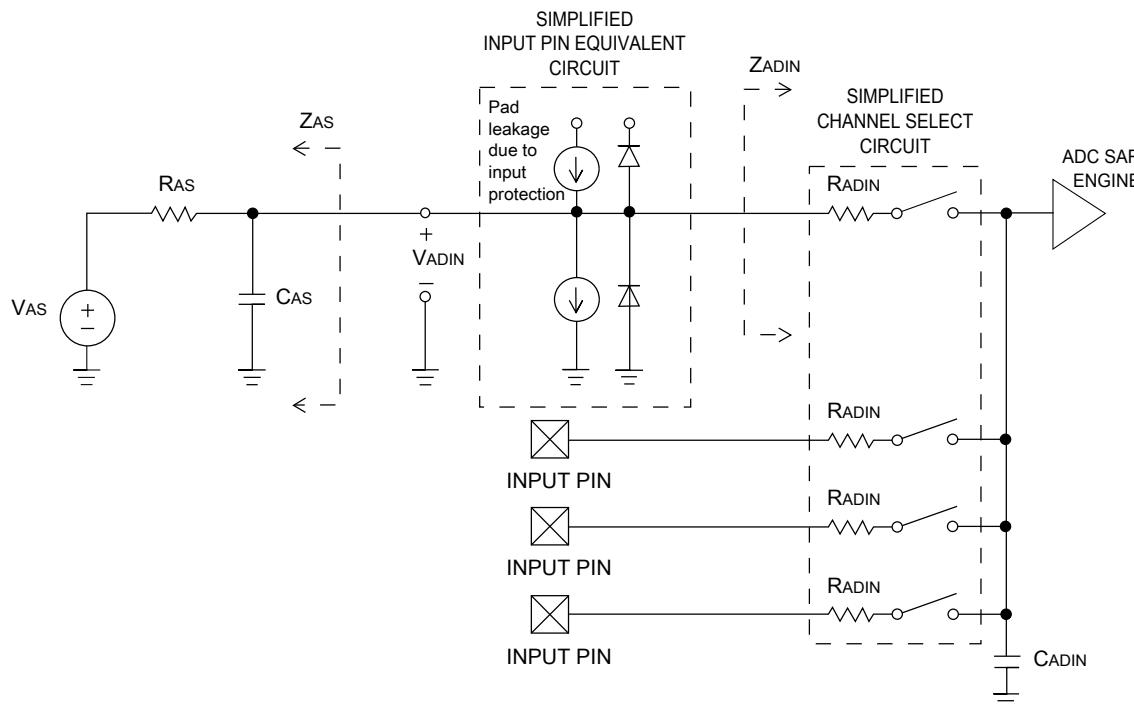
Symbol	Description	Conditions	Min.	Typ. <sup>1</sup>	Max.	Unit	Notes
V <sub>DDA</sub>	Supply voltage	Absolute	1.71	—	3.6	V	—
ΔV <sub>DDA</sub>	Supply voltage	Delta to V <sub>DD</sub> (V <sub>DD</sub> – V <sub>DDA</sub> )	-100	0	+100	mV	<a href="#">2</a>
ΔV <sub>SSA</sub>	Ground voltage	Delta to V <sub>SS</sub> (V <sub>SS</sub> – V <sub>SSA</sub> )	-100	0	+100	mV	<a href="#">2</a>
V <sub>REFH</sub>	ADC reference voltage high		1.13	V <sub>DDA</sub>	V <sub>DDA</sub>	V	
V <sub>REFL</sub>	ADC reference voltage low		V <sub>SSA</sub>	V <sub>SSA</sub>	V <sub>SSA</sub>	V	
V <sub>ADIN</sub>	Input voltage	<ul style="list-style-type: none"> <li>• 16-bit differential mode</li> <li>• All other modes</li> </ul>	V <sub>REFL</sub> V <sub>REFL</sub>	— —	31/32 * V <sub>REFH</sub> V <sub>REFH</sub>	V	—
C <sub>ADIN</sub>	Input capacitance	<ul style="list-style-type: none"> <li>• 16-bit mode</li> <li>• 8-bit / 10-bit / 12-bit modes</li> </ul>	— —	8 4	10 5	pF	—
R <sub>ADIN</sub>	Input series resistance		—	2	5	kΩ	—
R <sub>AS</sub>	Analog source resistance (external)	13-bit / 12-bit modes f <sub>ADCK</sub> < 4 MHz	—	—	5	kΩ	<a href="#">3</a>
f <sub>ADCK</sub>	ADC conversion clock frequency	≤ 13-bit mode	1.0	—	18.0	MHz	<a href="#">4</a>
f <sub>ADCK</sub>	ADC conversion clock frequency	16-bit mode	2.0	—	12.0	MHz	<a href="#">4</a>
C <sub>rate</sub>	ADC conversion rate	≤ 13-bit modes No ADC hardware averaging	20.000	—	818.330	Ksps	<a href="#">5</a>

Table continues on the next page...

**Table 27. 16-bit ADC operating conditions (continued)**

Symbol	Description	Conditions	Min.	Typ. <sup>1</sup>	Max.	Unit	Notes
		Continuous conversions enabled, subsequent conversion time					
C <sub>rate</sub>	ADC conversion rate	16-bit mode No ADC hardware averaging Continuous conversions enabled, subsequent conversion time	37.037	—	461.467	Ksps	5

1. Typical values assume V<sub>DDA</sub> = 3.0 V, Temp = 25 °C, f<sub>ADCK</sub> = 1.0 MHz, unless otherwise stated. Typical values are for reference only, and are not tested in production.
2. DC potential difference.
3. This resistance is external to MCU. To achieve the best results, the analog source resistance must be kept as low as possible. The results in this data sheet were derived from a system that had < 8 Ω analog source resistance. The R<sub>AS</sub>/C<sub>AS</sub> time constant should be kept to < 1 ns.
4. To use the maximum ADC conversion clock frequency, CFG2[ADHSC] must be set and CFG1[ADLPC] must be clear.
5. For guidelines and examples of conversion rate calculation, download the [ADC calculator tool](#).

**Figure 15. ADC input impedance equivalency diagram**

### 3.6.1.2 16-bit ADC electrical characteristics

**Table 33. VREF full-range operating behaviors**

Symbol	Description	Min.	Typ.	Max.	Unit	Notes
$V_{out}$	Voltage reference output with factory trim at nominal $V_{DDA}$ and temperature=25C	1.1915	1.195	1.1977	V	<a href="#">1</a>
$V_{out}$	Voltage reference output — factory trim	1.1584	—	1.2376	V	<a href="#">1</a>
$V_{out}$	Voltage reference output — user trim	1.193	—	1.197	V	<a href="#">1</a>
$V_{step}$	Voltage reference trim step	—	0.5	—	mV	<a href="#">1</a>
$V_{tdrift}$	Temperature drift (Vmax -Vmin across the full temperature range)	—	—	80	mV	<a href="#">1</a>
$I_{bg}$	Bandgap only current	—	—	80	$\mu A$	<a href="#">1</a>
$\Delta V_{LOAD}$	Load regulation • current = $\pm 1.0$ mA	—	200	—	$\mu V$	<a href="#">1, 2</a>
$T_{stup}$	Buffer startup time	—	—	100	$\mu s$	—
$V_{vdrift}$	Voltage drift (Vmax -Vmin across the full voltage range)	—	2	—	mV	<a href="#">1</a>

1. See the chip's Reference Manual for the appropriate settings of the VREF Status and Control register.
2. Load regulation voltage is the difference between the VREF\_OUT voltage with no load vs. voltage with defined load

**Table 34. VREF limited-range operating requirements**

Symbol	Description	Min.	Max.	Unit	Notes
$T_A$	Temperature	0	50	$^{\circ}C$	—

**Table 35. VREF limited-range operating behaviors**

Symbol	Description	Min.	Max.	Unit	Notes
$V_{out}$	Voltage reference output with factory trim	1.173	1.225	V	—

## 3.7 Timers

See [General switching specifications](#).

## 3.8 Communication interfaces

### 3.8.1 USB electrical specifications

The USB electicals for the USB On-the-Go module conform to the standards documented by the Universal Serial Bus Implementers Forum. For the most up-to-date standards, visit [usb.org](http://usb.org).

#### NOTE

The MCGFLLCLK does not meet the USB jitter specifications for certification.

### 3.8.2 USB DCD electrical specifications

**Table 36. USB0 DCD electrical specifications**

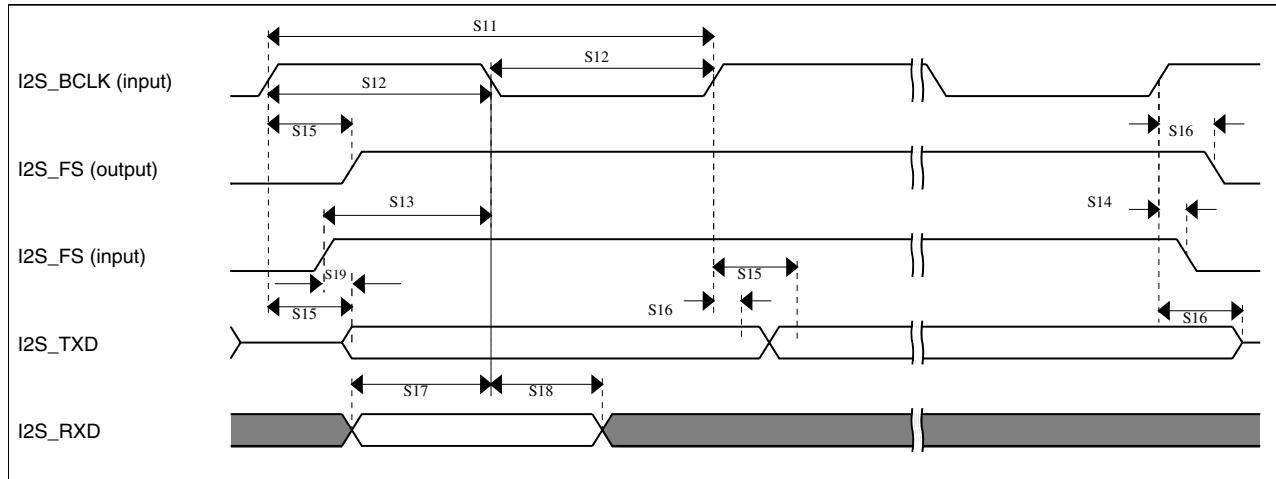
Symbol	Description	Min.	Typ.	Max.	Unit
V <sub>DP_SRC</sub>	USB_DP source voltage (up to 250 $\mu$ A)	0.5	—	0.7	V
V <sub>LGC</sub>	Threshold voltage for logic high	0.8	—	2.0	V
I <sub>DP_SRC</sub>	USB_DP source current	7	10	13	$\mu$ A
I <sub>DM_SINK</sub>	USB_DM sink current	50	100	150	$\mu$ A
R <sub>DM_DWN</sub>	D-pulldown resistance for data pin contact detect	14.25	—	24.8	k $\Omega$
V <sub>DAT_REF</sub>	Data detect voltage	0.25	0.33	0.4	V

### 3.8.3 USB VREG electrical specifications

**Table 37. USB VREG electrical specifications**

Symbol	Description	Min.	Typ. <sup>1</sup>	Max.	Unit	Notes
VREGIN	Input supply voltage	2.7	—	5.5	V	
I <sub>DDon</sub>	Quiescent current — Run mode, load current equal zero, input supply (VREGIN) > 3.6 V	—	125	186	$\mu$ A	
I <sub>DDstby</sub>	Quiescent current — Standby mode, load current equal zero	—	1.1	10	$\mu$ A	
I <sub>DDoff</sub>	Quiescent current — Shutdown mode <ul style="list-style-type: none"> <li>• VREGIN = 5.0 V and temperature=25 °C</li> <li>• Across operating voltage and temperature</li> </ul>	—	650 —	— 4	nA $\mu$ A	
I <sub>LOADrun</sub>	Maximum load current — Run mode	—	—	120	mA	
I <sub>LOADstby</sub>	Maximum load current — Standby mode	—	—	1	mA	
V <sub>Reg33out</sub>	Regulator output voltage — Input supply (VREGIN) > 3.6 V					

*Table continues on the next page...*



**Figure 28. I<sup>2</sup>S timing — slave modes**

### 3.8.10.1 Normal Run, Wait and Stop mode performance over the full operating voltage range

This section provides the operating performance over the full operating voltage for the device in Normal Run, Wait and Stop modes.

**Table 45. I<sup>2</sup>S/SAI master mode timing**

Num.	Characteristic	Min.	Max.	Unit
	Operating voltage	1.71	3.6	V
S1	I <sup>2</sup> S_MCLK cycle time	40	—	ns
S2	I <sup>2</sup> S_MCLK (as an input) pulse width high/low	45%	55%	MCLK period
S3	I <sup>2</sup> S_TX_BCLK/I <sup>2</sup> S_RX_BCLK cycle time (output)	80	—	ns
S4	I <sup>2</sup> S_TX_BCLK/I <sup>2</sup> S_RX_BCLK pulse width high/low	45%	55%	BCLK period
S5	I <sup>2</sup> S_TX_BCLK/I <sup>2</sup> S_RX_BCLK to I <sup>2</sup> S_TX_FS/ I <sup>2</sup> S_RX_FS output valid	—	15	ns
S6	I <sup>2</sup> S_TX_BCLK/I <sup>2</sup> S_RX_BCLK to I <sup>2</sup> S_TX_FS/ I <sup>2</sup> S_RX_FS output invalid	-1	—	ns
S7	I <sup>2</sup> S_TX_BCLK to I <sup>2</sup> S_TXD valid	—	15	ns
S8	I <sup>2</sup> S_TX_BCLK to I <sup>2</sup> S_TXD invalid	0	—	ns
S9	I <sup>2</sup> S_RXD/I <sup>2</sup> S_RX_FS input setup before I <sup>2</sup> S_RX_BCLK	20.5	—	ns
S10	I <sup>2</sup> S_RXD/I <sup>2</sup> S_RX_FS input hold after I <sup>2</sup> S_RX_BCLK	0	—	ns

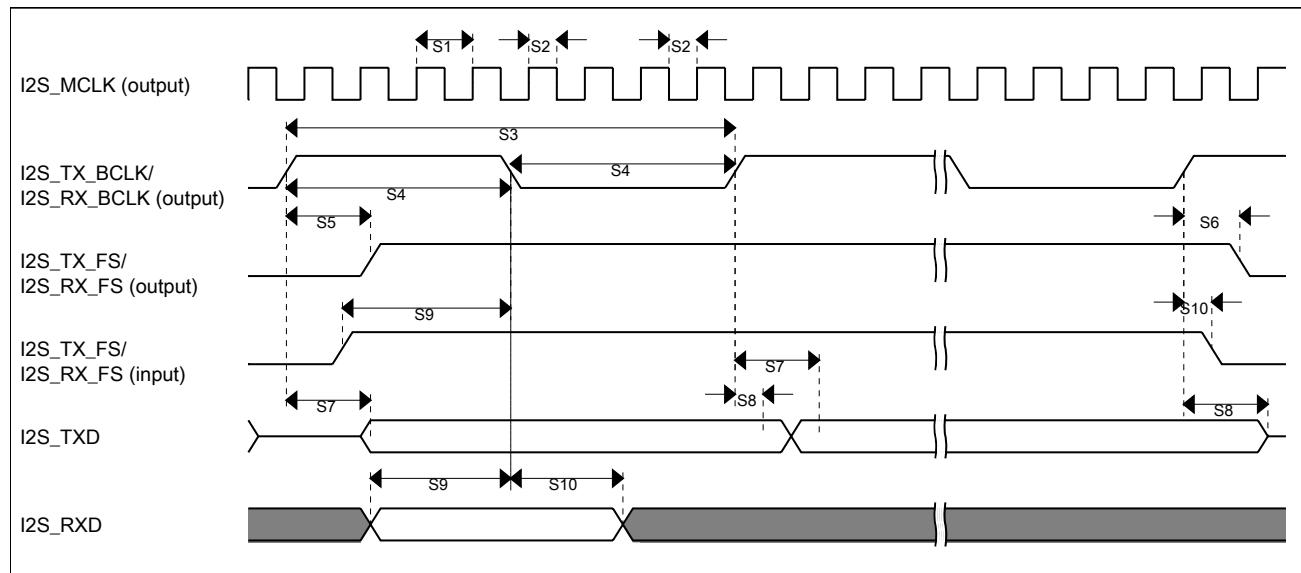
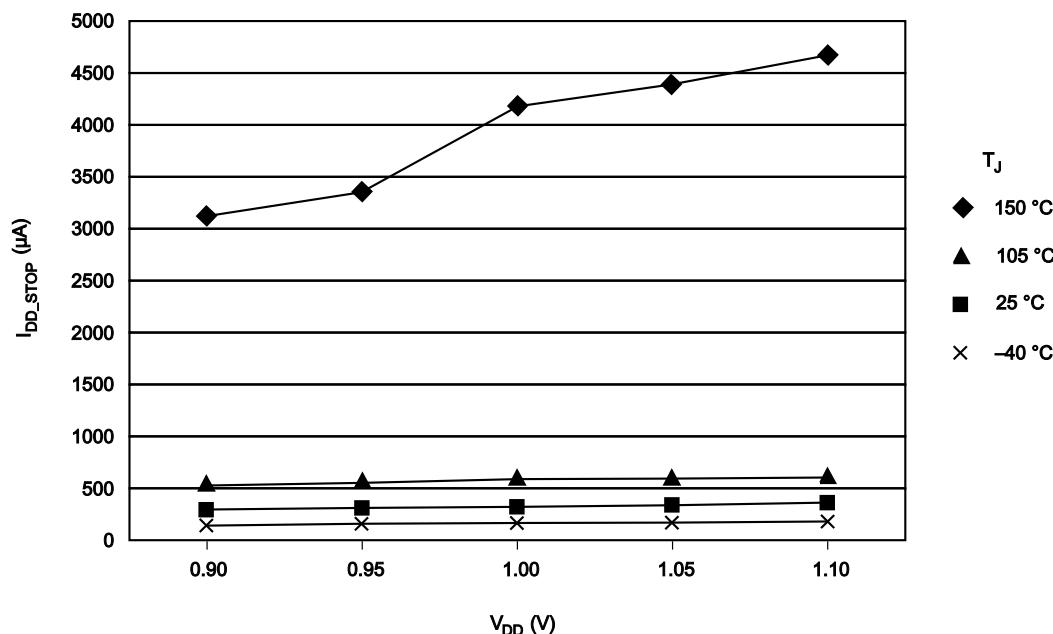


Figure 31. I2S/SAI timing — master modes

Table 48. I2S/SAI slave mode timing in VLPR, VLPW, and VLPS modes (full voltage range)

Num.	Characteristic	Min.	Max.	Unit
	Operating voltage	1.71	3.6	V
S11	I2S_TX_BCLK/I2S_RX_BCLK cycle time (input)	250	—	ns
S12	I2S_TX_BCLK/I2S_RX_BCLK pulse width high/low (input)	45%	55%	MCLK period
S13	I2S_TX_FS/I2S_RX_FS input setup before I2S_TX_BCLK/I2S_RX_BCLK	30	—	ns
S14	I2S_TX_FS/I2S_RX_FS input hold after I2S_TX_BCLK/I2S_RX_BCLK	—	—	ns
S15	I2S_TX_BCLK to I2S_TXD/I2S_TX_FS output valid	—	—	ns
S16	I2S_TX_BCLK to I2S_TXD/I2S_TX_FS output invalid	0	—	ns
S17	I2S_RXD setup before I2S_RX_BCLK	30	—	ns
S18	I2S_RXD hold after I2S_RX_BCLK	—	—	ns
S19	I2S_TX_FS input assertion to I2S_TXD output valid <sup>1</sup>	—	72	ns

1. Applies to first bit in each frame and only if the TCR4[FSE] bit is clear



### 3.8.10.5.9 Typical value conditions

Typical values assume you meet the following conditions (or other conditions as specified):

Symbol	Description	Value	Unit
$T_A$	Ambient temperature	25	°C
$V_{DD}$	3.3 V supply voltage	3.3	V

## 4 Dimensions

### 4.1 Obtaining package dimensions

Package dimensions are provided in package drawings.

To find a package drawing, go to [freescale.com](http://freescale.com) and perform a keyword search for the drawing's document number:

If you want the drawing for this package	Then use this document number
144-pin LQFP	98ASS23177W

Table continues on the next page...

**Pinout**

144 MAP BGA	144 LQFP	Pin Name	Default	ALT0	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	EzPort
H5	31	VDDA	VDDA	VDDA								
G5	32	VREFH	VREFH	VREFH								
G6	33	VREFL	VREFL	VREFL								
H6	34	VSSA	VSSA	VSSA								
K3	35	ADC1_SE16/ CMP2_IN2/ ADC0_SE22	ADC1_SE16/ CMP2_IN2/ ADC0_SE22	ADC1_SE16/ CMP2_IN2/ ADC0_SE22								
J3	36	ADC0_SE16/ CMP1_IN2/ ADC0_SE21	ADC0_SE16/ CMP1_IN2/ ADC0_SE21	ADC0_SE16/ CMP1_IN2/ ADC0_SE21								
M3	—	VREF_OUT/ CMP1_IN5/ CMP0_IN5/ ADC1_SE18	VREF_OUT/ CMP1_IN5/ CMP0_IN5/ ADC1_SE18	VREF_OUT/ CMP1_IN5/ CMP0_IN5/ ADC1_SE18								
L3	—	DAC0_OUT/ CMP1_IN3/ ADC0_SE23	DAC0_OUT/ CMP1_IN3/ ADC0_SE23	DAC0_OUT/ CMP1_IN3/ ADC0_SE23								
L4	—	DAC1_OUT/ CMP0_IN4/ CMP2_IN3/ ADC1_SE23	DAC1_OUT/ CMP0_IN4/ CMP2_IN3/ ADC1_SE23	DAC1_OUT/ CMP0_IN4/ CMP2_IN3/ ADC1_SE23								
L5	37	TAMPER0/ RTC_ WAKEUP_B	TAMPER0/ RTC_ WAKEUP_B	TAMPER0/ RTC_ WAKEUP_B								
K5	38	TAMPER1	TAMPER1	TAMPER1								
K4	39	TAMPER2	TAMPER2	TAMPER2								
J4	—	TAMPER3	TAMPER3	TAMPER3								
H4	—	TAMPER4	TAMPER4	TAMPER4								
M4	—	TAMPER5	TAMPER5	TAMPER5								
M7	40	XTAL32	XTAL32	XTAL32								
M6	41	EXTAL32	EXTAL32	EXTAL32								
L6	42	VBAT	VBAT	VBAT								
—	43	VDD	VDD	VDD								
—	44	VSS	VSS	VSS								
—	45	PTE24	ADC0_SE17	ADC0_SE17	PTE24		UART4_TX			EWM_OUT_b		
—	46	PTE25	ADC0_SE18	ADC0_SE18	PTE25		UART4_RX			EWM_IN		
—	47	PTE26	DISABLED		PTE26		UART4_CTS_b			RTC_CLKOUT	USB_CLKIN	
—	48	PTE27	DISABLED		PTE27		UART4_RTS_b					
—	49	PTE28	DISABLED		PTE28							

**Pinout**

144 MAP BGA	144 LQFP	Pin Name	Default	ALT0	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	EzPort
K12	75	PTA24	DISABLED		PTA24					FB_A29		
J12	76	PTA25	DISABLED		PTA25					FB_A28		
J11	77	PTA26	DISABLED		PTA26					FB_A27		
J10	78	PTA27	DISABLED		PTA27					FB_A26		
H12	79	PTA28	DISABLED		PTA28					FB_A25		
H11	80	PTA29	DISABLED		PTA29					FB_A24		
H10	81	PTB0/ LLWU_P5	ADC0_SE8/ ADC1_SE8	ADC0_SE8/ ADC1_SE8	PTB0/ LLWU_P5	I2C0_SCL	FTM1_CH0			FTM1_QD_ PHA		
H9	82	PTB1	ADC0_SE9/ ADC1_SE9	ADC0_SE9/ ADC1_SE9	PTB1	I2C0_SDA	FTM1_CH1			FTM1_QD_ PHB		
G12	83	PTB2	ADC0_SE12	ADC0_SE12	PTB2	I2C0_SCL	UART0_ RTS_b			FTM0_FLT3		
G11	84	PTB3	ADC0_SE13	ADC0_SE13	PTB3	I2C0_SDA	UART0_ CTS_b			FTM0_FLT0		
G10	85	PTB4	ADC1_SE10	ADC1_SE10	PTB4					FTM1_FLT0		
G9	86	PTB5	ADC1_SE11	ADC1_SE11	PTB5					FTM2_FLT0		
F12	87	PTB6	ADC1_SE12	ADC1_SE12	PTB6					FB_AD23		
F11	88	PTB7	ADC1_SE13	ADC1_SE13	PTB7					FB_AD22		
F10	89	PTB8	DISABLED		PTB8		UART3_ RTS_b			FB_AD21		
F9	90	PTB9	DISABLED		PTB9	SPI1_PCS1	UART3_ CTS_b			FB_AD20		
E12	91	PTB10	ADC1_SE14	ADC1_SE14	PTB10	SPI1_PCS0	UART3_RX			FB_AD19	FTM0_FLT1	
E11	92	PTB11	ADC1_SE15	ADC1_SE15	PTB11	SPI1_SCK	UART3_TX			FB_AD18	FTM0_FLT2	
H7	93	VSS	VSS	VSS								
F5	94	VDD	VDD	VDD								
E10	95	PTB16	DISABLED		PTB16	SPI1_SOUT	UART0_RX	FTM_CLKIN0	FB_AD17	EWM_IN		
E9	96	PTB17	DISABLED		PTB17	SPI1_SIN	UART0_TX	FTM_CLKIN1	FB_AD16	EWM_OUT_ b		
D12	97	PTB18	DISABLED		PTB18	CAN0_TX	FTM2_CH0	I2S0_TX_ BCLK	FB_AD15	FTM2_QD_ PHA		
D11	98	PTB19	DISABLED		PTB19	CAN0_RX	FTM2_CH1	I2S0_TX_FS	FB_OE_b	FTM2_QD_ PHB		
D10	99	PTB20	DISABLED		PTB20	SPI2_PCS0				FB_AD31	CMP0_OUT	
D9	100	PTB21	DISABLED		PTB21	SPI2_SCK				FB_AD30	CMP1_OUT	
C12	101	PTB22	DISABLED		PTB22	SPI2_SOUT				FB_AD29	CMP2_OUT	
C11	102	PTB23	DISABLED		PTB23	SPI2_SIN	SPI0_PCS5			FB_AD28		
B12	103	PTC0	ADC0_SE14	ADC0_SE14	PTC0	SPI0_PCS4	PDB0_ EXTRG			FB_AD14	I2S0_TXD1	
B11	104	PTC1/ LLWU_P6	ADC0_SE15	ADC0_SE15	PTC1/ LLWU_P6	SPI0_PCS3	UART1_ CTS_b	FTM0_CH0	FB_AD13	I2S0_TXD0		

144 MAP BGA	144 LQFP	Pin Name	Default	ALT0	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	EzPort
A12	105	PTC2	ADC0_SE4b/ CMP1_IN0	ADC0_SE4b/ CMP1_IN0	PTC2	SPI0_PCS2	UART1_ CTS_b	FTM0_CH1	FB_AD12	I2S0_RX_FS		
A11	106	PTC3/ LLWU_P7	CMP1_IN1	CMP1_IN1	PTC3/ LLWU_P7	SPI0_PCS1	UART1_RX	FTM0_CH2	CLKOUT	I2S0_TX_ BCLK		
H8	107	VSS	VSS	VSS								
—	108	VDD	VDD	VDD								
A9	109	PTC4/ LLWU_P8	DISABLED		PTC4/ LLWU_P8	SPI0_PCS0	UART1_TX	FTM0_CH3	FB_AD11	CMP1_OUT		
D8	110	PTC5/ LLWU_P9	DISABLED		PTC5/ LLWU_P9	SPI0_SCK	LPTMR0_ ALT2	I2S0_RXD0	FB_AD10	CMP0_OUT	FTM0_CH2	
C8	111	PTC6/ LLWU_P10	CMP0_IN0	CMP0_IN0	PTC6/ LLWU_P10	SPI0_SOUT	PDB0_ EXTRG	I2S0_RX_ BCLK	FB_AD9	I2S0_MCLK		
B8	112	PTC7	CMP0_IN1	CMP0_IN1	PTC7	SPI0_SIN	USB_SOF_ OUT	I2S0_RX_FS	FB_AD8			
A8	113	PTC8	ADC1_SE4b/ CMP0_IN2	ADC1_SE4b/ CMP0_IN2	PTC8		FTM3_CH4	I2S0_MCLK	FB_AD7			
D7	114	PTC9	ADC1_SE5b/ CMP0_IN3	ADC1_SE5b/ CMP0_IN3	PTC9		FTM3_CH5	I2S0_RX_ BCLK	FB_AD6	FTM2_FLT0		
C7	115	PTC10	ADC1_SE6b	ADC1_SE6b	PTC10	I2C1_SCL	FTM3_CH6	I2S0_RX_FS	FB_AD5			
B7	116	PTC11/ LLWU_P11	ADC1_SE7b	ADC1_SE7b	PTC11/ LLWU_P11	I2C1_SDA	FTM3_CH7	I2S0_RXD1	FB_RW_b			
A7	117	PTC12	DISABLED		PTC12		UART4_ RTS_b		FB_AD27	FTM3_FLT0		
D6	118	PTC13	DISABLED		PTC13		UART4_ CTS_b		FB_AD26			
C6	119	PTC14	DISABLED		PTC14		UART4_RX		FB_AD25			
B6	120	PTC15	DISABLED		PTC15		UART4_TX		FB_AD24			
—	121	VSS	VSS	VSS								
—	122	VDD	VDD	VDD								
A6	123	PTC16	DISABLED		PTC16		UART3_RX		FB_CS5_b/ FB_TSIZ1/ FB_BE23_ 16_BLS15_ 8_b			
D5	124	PTC17	DISABLED		PTC17		UART3_TX		FB_CS4_b/ FB_TSIZ0/ FB_BE31_ 24_BLS7_0_b			
C5	125	PTC18	DISABLED		PTC18		UART3_ RTS_b		FB_TBST_b/ FB_CS2_b/ FB_BE15_8_ BLS23_16_b			
B5	126	PTC19	DISABLED		PTC19		UART3_ CTS_b		FB_CS3_b/ FB_BE7_0_ BLS31_24_b	FB_TA_b		

**Pinout**

144 MAP BGA	144 LQFP	Pin Name	Default	ALT0	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	EzPort
A5	127	PTD0/ LLWU_P12	DISABLED		PTD0/ LLWU_P12	SPI0_PCS0	UART2_ RTS_b	FTM3_CH0	FB_ALE/ FB_CS1_b/ FB_TS_b			
D4	128	PTD1	ADC0_SE5b	ADC0_SE5b	PTD1	SPI0_SCK	UART2_ CTS_b	FTM3_CH1	FB_CS0_b			
C4	129	PTD2/ LLWU_P13	DISABLED		PTD2/ LLWU_P13	SPI0_SOUT	UART2_RX	FTM3_CH2	FB_AD4		I2C0_SCL	
B4	130	PTD3	DISABLED		PTD3	SPI0_SIN	UART2_TX	FTM3_CH3	FB_AD3		I2C0_SDA	
A4	131	PTD4/ LLWU_P14	DISABLED		PTD4/ LLWU_P14	SPI0_PCS1	UART0_ RTS_b	FTM0_CH4	FB_AD2	EWM_IN		
A3	132	PTD5	ADC0_SE6b	ADC0_SE6b	PTD5	SPI0_PCS2	UART0_ CTS_b	FTM0_CH5	FB_AD1	EWM_OUT_b		
A2	133	PTD6/ LLWU_P15	ADC0_SE7b	ADC0_SE7b	PTD6/ LLWU_P15	SPI0_PCS3	UART0_RX	FTM0_CH6	FB_AD0	FTM0_FLT0		
M10	134	VSS	VSS	VSS								
F8	135	VDD	VDD	VDD								
A1	136	PTD7	DISABLED		PTD7	CMT_IRO	UART0_TX	FTM0_CH7		FTM0_FLT1		
C9	137	PTD8	DISABLED		PTD8	I2C0_SCL	UART5_RX			FB_A16		
B9	138	PTD9	DISABLED		PTD9	I2C0_SDA	UART5_TX			FB_A17		
B3	139	PTD10	DISABLED		PTD10		UART5_ RTS_b			FB_A18		
B2	140	PTD11	DISABLED		PTD11	SPI2_PCS0	UART5_ CTS_b	SDHC0_CLKIN		FB_A19		
B1	141	PTD12	DISABLED		PTD12	SPI2_SCK	FTM3_FLT0	SDHC0_D4		FB_A20		
C3	142	PTD13	DISABLED		PTD13	SPI2_SOUT		SDHC0_D5		FB_A21		
C2	143	PTD14	DISABLED		PTD14	SPI2_SIN		SDHC0_D6		FB_A22		
C1	144	PTD15	DISABLED		PTD15	SPI2_PCS1		SDHC0_D7		FB_A23		
M5	—	NC	NC	NC								
A10	—	NC	NC	NC								
B10	—	NC	NC	NC								
C10	—	NC	NC	NC								

## 5.2 K21 Pinouts

The below figure shows the pinout diagram for the devices supported by this document. Many signals may be multiplexed onto a single pin. To determine what signals can be used on which pin, see the previous section.